

KBJL606 THRU KBJL610 Glass Passivated Single-Phase Bridge Rectifiers

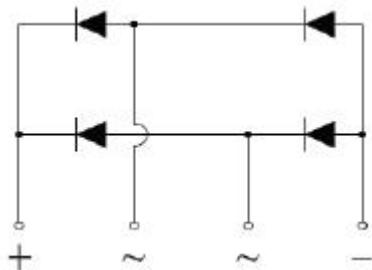


KBJL

Features

- Thin Single in-line low profile package ideal for compact required circuit
- Glass passivated junction
- High surge current capability
- This is a Pb - Free Device
- All SMC parts are traceable to the wafer lot
- Additional testing can be offered upon request

Circuit Diagram



Mechanical Data

- Case: KBJL, Molding compound, UL flammability classification rating 94V-0
- Terminals: Matte tin plated leads, solderable per JESD22-B102 Meet JESD 201 class 2 whisker test
- Polarity: as marked on case
- Mounting torque: 0.5N.m is recommended
- Weight: 2.6 g (approximately)

Maximum Ratings @ $T_A=25^\circ\text{C}$ unless otherwise specified

Type Number	Symbol	KBJL606	KBJL608	KBJL610	Units
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V_{RRM} V_{RWM} V_{DC}	600	800	1000	V
RMS Reverse Voltage	V_{RMS}	420	560	700	V
Maximum average forward rectified current	$I_{F(AV)}$		6		A
Non-Repetitive Peak Forward Surge Current 8.3ms Single half sine-wave	I_{FSM}		150		A
Non-Repetitive Peak Forward Surge Current 1ms Single half sine-wave	I_{FSM}		280		A
Rating of fusing (t<8.3ms)	I^2t		93		A^2s

Electrical Characteristics@ $T_A=25^\circ\text{C}$ unless otherwise specified

Type Number	Symbol	KBJL606	KBJL608	KBJL610	Units
Forward Voltage @ $I_F = 3\text{A}$	V_F		1.05		V
Peak Reverse Current @ $T_A = 25^\circ\text{C}$ At Rated DC Blocking Voltage @ $T_A = 125^\circ\text{C}$	I_{RM}		5.0 150		μA

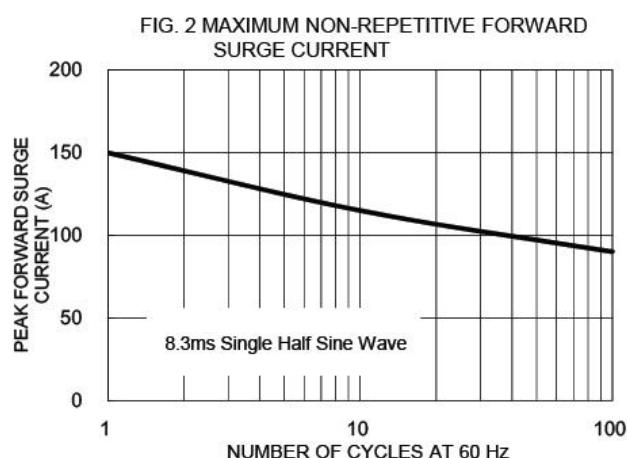
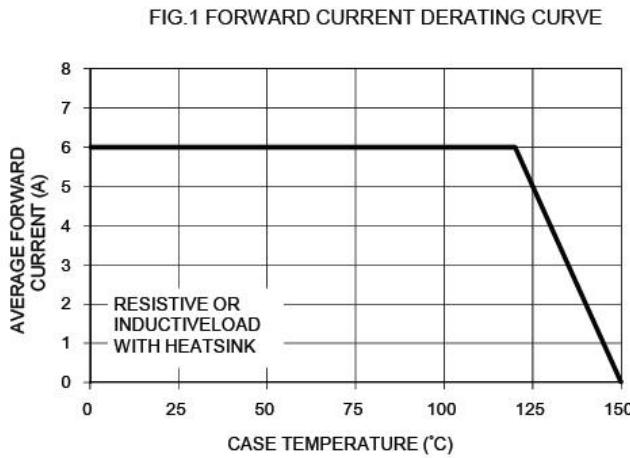
* Pulse width < 300 μs , duty cycle < 2%

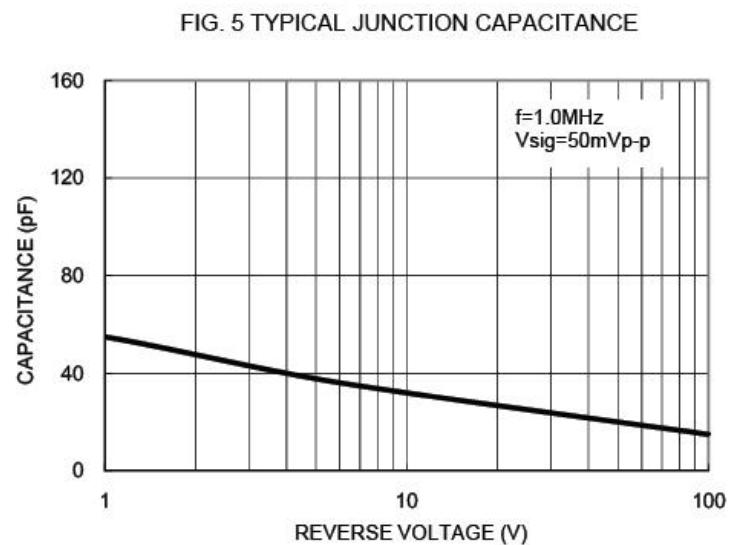
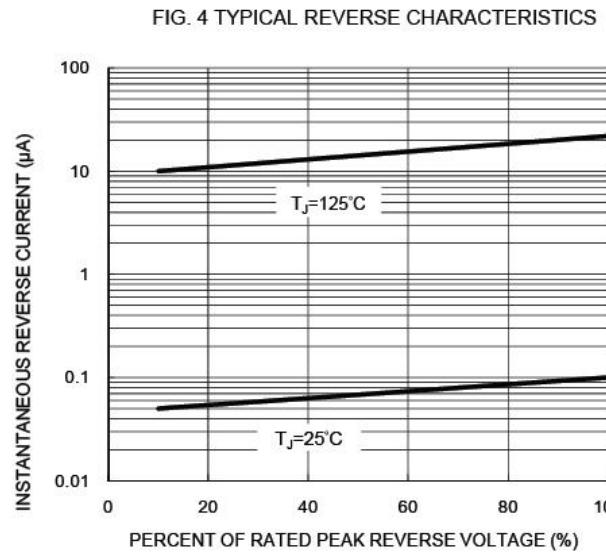
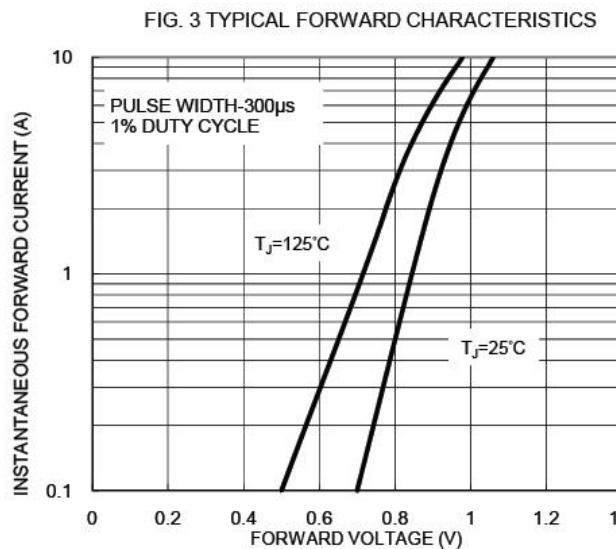
Thermal-Mechanical Specifications:

Type Number	Symbol	KBJL606	KBJL608	KBJL610	Units
Typical Thermal Resistance (Notes)	$R_{\theta JC}$ $R_{\theta JA}$		2 7		$^\circ\text{C}/\text{W}$
Operating and Storage Temperature Range	T_J, T_{STG}		-55 to +150		$^\circ\text{C}$

Note: 1. Mount on Heatsink size of 4" x 6" x 0.25" Al-Plate

Ratings and Characteristics Curves



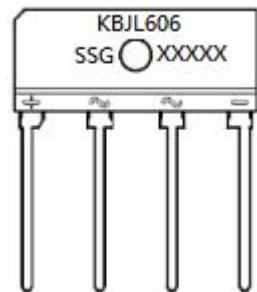


Ordering Information

Device	Package	Plating	Shipping
KBJL606 THRU KBJL610	KBJL	Pure Sn	20pcs / tube

For information on tape and reel specifications, including part orientation and tape sizes, please refer to our tape and reel packaging specification.

Marking Diagram

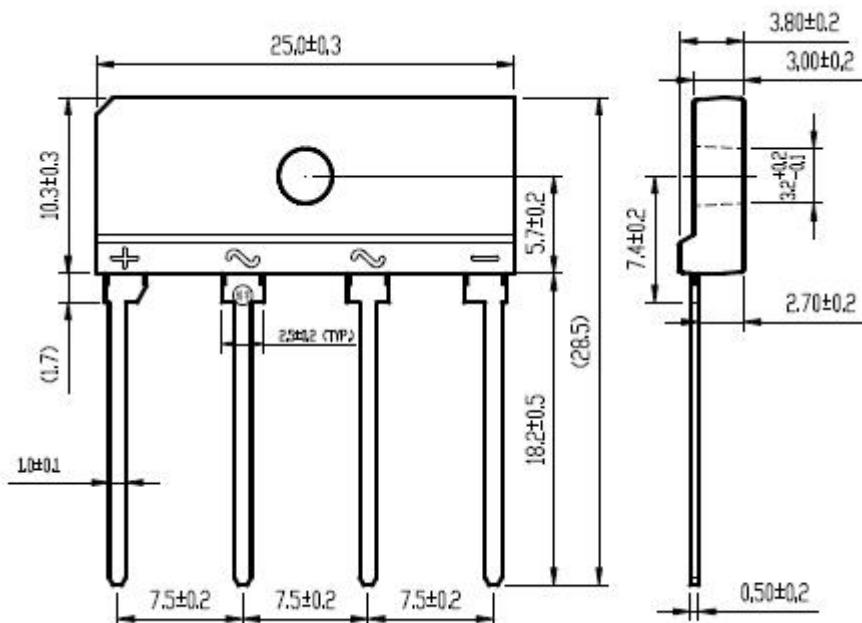


Where XXXXX is YYWWL

KBJL606 = Type Number
 SSG = SSG
 YY = Year
 WW = Week
 L = Lot Number

Cautions: Molding resin
Epoxy resin UL:94V-0

Mechanical Dimensions KBJL



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